

**ON Semiconductor®** 

## **FDMC7692S** N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> **30 V, 18 A, 9.3 m**Ω

## **Features**

- Max  $r_{DS(on)}$  = 9.3 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 12.5 A
- Max r<sub>DS(on)</sub> = 13.6 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 10.4 A
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

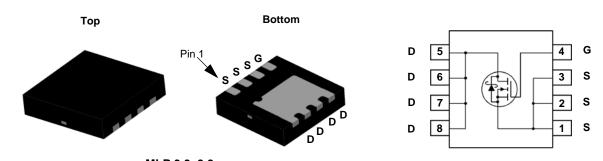


## **General Description**

This FDMC7692S is produced using ON Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery packs.

## **Applications**

- DC DC Buck Converters
- Notebook DC DC application



MLP 3.3x3.3

## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to So	ource Voltage			30	V
V <sub>GS</sub>	Gate to So	urce Voltage			±20	V
I <sub>D</sub>	Drain Current -Continuous $T_C = 25 \text{ °C}$		18			
		-Continuous $T_A = 25 \text{ °C}$ (Note 1a)		12.5	А	
		-Pulsed			45	
E <sub>AS</sub>	Sinlge Puls	se Avalanche Energy		(Note 3)	21	mJ
P <sub>D</sub>	Power Diss	sipation	T <sub>C</sub> = 25 °C	;	27	W
	Power Diss	sipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	
Thermal Cl						
R <sub>0JC</sub>	Thermal R	esistance, Junction to C	ase		4.7	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)			53	°C/W	
Package M	arking and	I Ordering Informa	ation			
Device M	arking	Device	Package	Reel Size	Tape Width	Quantity

### 13 " MLP 3.3X3.3 FDMC7692S

FDMC7692S

3000 units

12 mm

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		16		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			500	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	1.2	2.0	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A	7.8 9.3		9.3	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10.4 A		10.8	13.6	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A T <sub>J</sub> = 125 °C		9.6	13.0	- 11152
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 12.5 A		62		S
-	Characteristics				1	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V,		1040	1385	pF
C <sub>oss</sub>	Output Capacitance	f = 1  MHz		445	590	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			40	60	pF
R <sub>g</sub>	Gate Resistance			1.1	2.9	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			9	17	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 12.5 A,		3	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		19	34	ns
t <sub>f</sub>	Fall Time			3	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		16	23	nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V $V_{DD} = 15$ V		8	10	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 12.5 A		4		nC

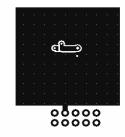
### **Drain-Source Diode Characteristics**

Gate to Drain "Miller" Charge

 $\mathsf{Q}_{\mathsf{gd}}$ 

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12.5 A (Note 2)	0.9	1.3	V
		$V_{GS} = 0 V, I_S = 0.9 A$ (Note 2)	0.5	0.7	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 12.5 A, di/dt = 300 A/μs	21	33	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$T_{\rm F} = 12.5 \text{A},  \text{u/ut} = 300 \text{A/}\mu\text{s}$	16	29	nC
Notes:					

1. R<sub>0,JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

a. 53 °C/W when mounted on a 1 in  $^2\,\text{pad}$  of 2 oz copper.

3. E<sub>AS</sub> of 21 mJ is based on starting T<sub>J</sub> = 25 °C, L = 0.3 mH, I<sub>AS</sub> = 12.0 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V. 100% test at L = 3 mH, I<sub>AS</sub> = 3.2 A .

b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

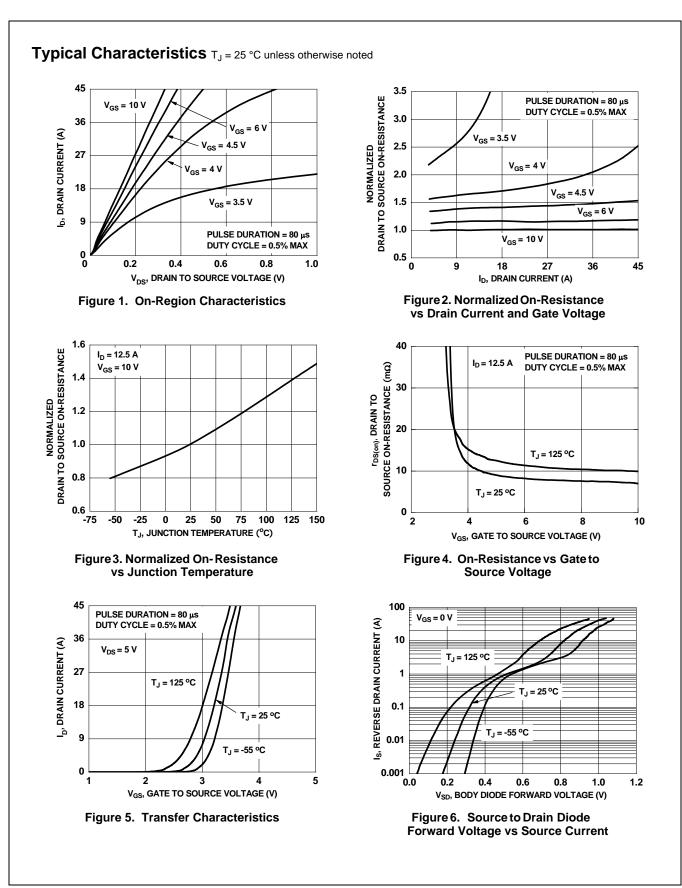
2

nC

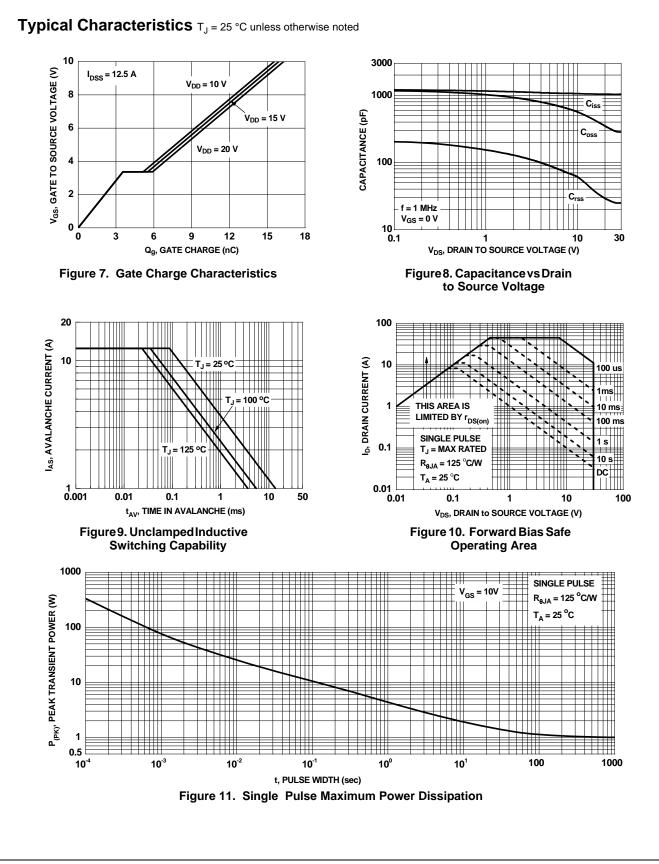




www.onsemi.com 2

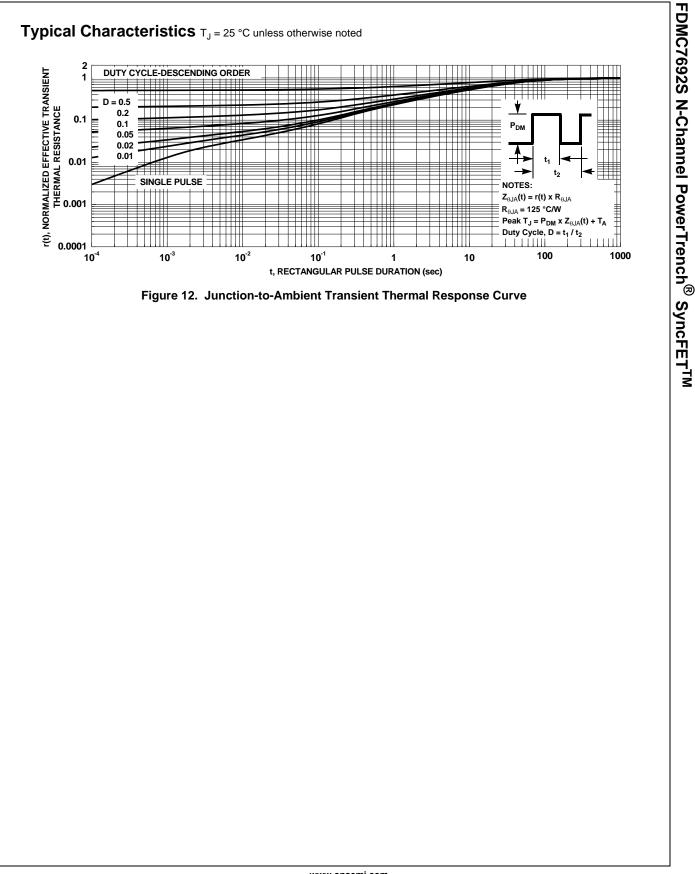


www.onsemi.com 3



FDMC7692S N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup>

www.onsemi.com 4



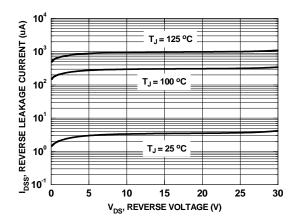
## Typical Characteristics (continued)

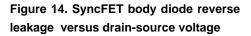
# SyncFET Schottky body diode Characteristics

ON Semiconductor's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 13 shows the reverse recovery characteristic of the FDMC7692S.

Figure 13. SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative